

Title (en)
ANTI-STATICALLY COATED MOULDED BODY AND METHOD FOR THE PRODUCTION THEREOF

Title (de)
ANTISTATISCH BESCHICHTETER FORMKÖRPER UND VERFAHREN ZU SEINER HERSTELLUNG

Title (fr)
CORPS MOULE A REVETEMENT ANTISTATIQUE ET PROCEDE DE FABRICATION DUDIT CORPS

Publication
EP 1603980 A1 20051214 (DE)

Application
EP 04716235 A 20040302

Priority
• EP 2004002063 W 20040302
• DE 10311639 A 20030314

Abstract (en)
[origin: DE10311639A1] A method for the production of plastic mouldings in which a moulding is coated with a varnish containing (based on the amount of binder) 5-500 parts by weight (pts. wt.) electrically conductive metal oxide powder with an average primary particle size of 1-80 nm and a degree of aggregation of 0.01-99% and 5-500 pts. wt. inert nano-particles. A method for the production of plastic mouldings involves coating the moulding on one or more sides with a varnish system containing (a) binder(s), (b) optionally solvent(s), (c) optionally other conventional additives, (d) optionally a thickener which may be a polymeric thickener with a content of 0-20% or an oligomeric thickener with a content of 0-40% (each based on dry film; components a, c, d, e), (e) 5-500 pts. wt. (based on a) electrically-conductive metal oxide powder with an average primary particle size of 1-80 nm and a degree of aggregation of 0.01-99% and (f) 5-500 pts. wt. inert nano-particles, and then hardening the varnish. An independent claim is also included for plastic mouldings made by this method, comprising PMMA, PC, PET, PET-G, PE, PVC, ABS or PP mouldings.

IPC 1-7
C09D 5/24; **H01B 1/20**; **H01B 1/24**

IPC 8 full level
C09D 5/24 (2006.01)

CPC (source: EP KR US)
C08J 7/16 (2013.01 - KR); **C09D 5/24** (2013.01 - EP KR US); **H01B 1/20** (2013.01 - KR); **B82Y 30/00** (2013.01 - KR); **Y10T 428/31511** (2015.04 - EP US)

Designated contracting state (EPC)
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LU MC NL PL PT RO SE SI SK TR

DOCDB simple family (publication)
DE 10311639 A1 20040923; CN 100381510 C 20080416; CN 1751105 A 20060322; EP 1603980 A1 20051214; HK 1088350 A1 20061103; JP 2006520681 A 20060914; JP 4308252 B2 20090805; KR 101007152 B1 20110112; KR 20050111768 A 20051128; TW 200427743 A 20041216; TW I313280 B 20090811; US 2006157675 A1 20060720; US 7608306 B2 20091027; WO 2004081122 A1 20040923; WO 2004081122 A8 20050728

DOCDB simple family (application)
DE 10311639 A 20030314; CN 200480004364 A 20040302; EP 04716235 A 20040302; EP 2004002063 W 20040302; HK 06108586 A 20060802; JP 2006504499 A 20040302; KR 20057017224 A 20040302; TW 93104973 A 20040226; US 54887805 A 20050914